

BOARD-TO-BOARD HEADERS & RECEPTACLES



✓ Active

TE CONNECTIVITY (TE)

.6FHR04H,140,S,GIG,08/Sn,HT,SEYes

0.6mm FH | .6mm FH

1-5316560-0

TE Internal Number: 1-5316560-0

EU RoHS Compliant

EU ELV Compliant

Connector Style Receptacle

Connector System Board-to-Board

Number of Positions 140

Centerline (Pitch) .6 mm [.024 in]

Stack Height 4 mm [.157 in]



PRODUCT DRAWING

Japanese



→ 3D PDF

DOCUMENTATION

Product Drawings

HARD TRAY ASSY FH 0.6BTB CONNECTOR REC 4H W/G-CONT

PDF (TIFF AVAILABLE)

Japanese

CAD Files

Customer View Model

2D_DXF.ZIP

English

Customer View Model

3D_IGS.ZIP

English

English	
3D PDF	
PDF	
English	
Product Specifications	
Application Specification	
AMP FH 0.6mm Pitch Board-To-Board Connector	
TIF	
English Control of the Control of th	
AMP FH 0.6mm Pitch Board-To-Board Connector PDF	
English	
FEATURES	+
Please review product documents or contact us for the latest agency approval information.	
Please Note: Use the Product Drawing for all design activity.	
Product Type Features	
Connector Style Receptacle	
Connector System Board-to-Board	
Connector & Contact Terminates To Printed Circuit Board Series Free Height	
PCB Mounting Orientation Vertical	
Boss With	
Product Type Connector	
Configuration Features	
Stackable Yes	
Number of Positions 140	
Board-to-Board Configuration Mezzanine Number of Rows 2	
Preloaded Yes	
Electrical Characteristics	
Dielectric Withstanding Voltage (VAC) 200	
Voltage (VAC) 50	
Body Features	
Sealant With	
Contact Features	

Customer View Model

3D_STP.ZIP

Solder Tail Contact Plating Material Gold, Tin **Grounding Contact** With Contact Plating Material Gold Flash, Nickel, Tin Contact Plating Thickness 0.05–0.127, 1, 1.3 **Contact Mating Area Plating Material** Gold Contact Mating Area Plating Thickness .2 µm [7.874 µin] Contact Current Rating (Max) (A) .5 Solder Tail Contact Plating Thickness (µm) .05, 1 Solder Tail Contact Plating Thickness (µin) 1.9685, 39.37 **Contact Base Material** Copper Alloy **Contact Type** Socket **Contact Layout Inline Termination Features Termination Method to PC Board** Surface Mount Mechanical Attachment **Mating Alignment** With Mating Alignment Type Polarization **PCB Mount Retention** With **PCB Mount Retention Type** Solder Peg **PCB Mount Alignment** With **PCB Mount Alignment Type** Locating Posts **Housing Features** Centerline (Pitch) .6 mm [.024 in] **Housing Material** High Temperature Thermoplastic **Dimensions** Stack Height 4 mm [.157 in] Height 4 mm [.157 in] **Usage Conditions Operating Temperature Range (°C)** -40 – 85 Operation/Application Pick and Place Cover Without For Use With Plug **Industry Standards UL Flammability Rating** UL 94V-0 **Packaging Features**

PRODUCT COMPLIANCE

Packaging Method Hard Tray

Packaging Quantity 30

Statement of Compliance

Statement of Compliance

PDF